

and the thickness of said conductive pattern is in the range from about 20 micrometers to about 50 micrometers.

20. The lamination ceramic chip inductor of claim 19, comprising a plurality of lamination layers connected together via through holes formed in at least one of the insulation layers.

REMARKS

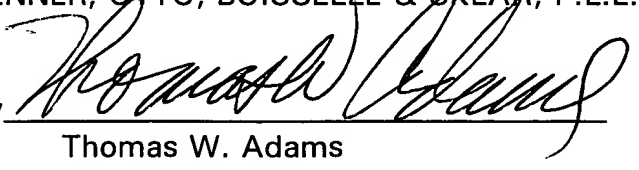
Upon entry of the present amendment, claims 1-20 are pending in the present application. The newly submitted claims 16-20 include two additional independent claims, and the appropriate fee is included herewith.

Newly submitted claims 16-20 are supported in the claims and specification of the parent application as originally filed, and at page 26, lines 7-14 of the present specification. No new matter is added by these amendments.

Should the Examiner feel that a telephone interview would be helpful to facilitate favorable prosecution of the above-identified application, the Examiner is invited to contact the undersigned at the telephone number provided below. If any additional fees are required for the filing of these papers, Applicants request the Commissioner to charge those fees to deposit account #18-0988.

Respectfully submitted,
RENNER, OTTO, BOISSELLE & SKLAR, P.L.L.

By


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